STP36N55M5
STW36N55M5

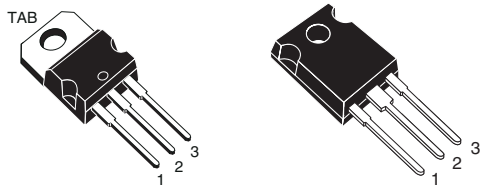
N-channel 550 V, 0.06 Ω typ., 33 A MDmesh™ V Power MOSFET in TO-220 and TO-247 packages

Datasheet — production data

Features

Order codes	V_{DSS} @ T_{Jmax}	$R_{DS(on)}$ max	I_D
STP36N55M5	600 V	< 0.08 Ω	33 A
STW36N55M5			

- Worldwide best $R_{DS(on)}$ * area
- Higher V_{DSS} rating and high dv/dt capability
- Excellent switching performance
- 100% avalanche tested



TO-220 **TO-247**

Applications

- Switching applications

Description

These devices are N-channel MDmesh™ V Power MOSFETs based on an innovative proprietary vertical process technology, which is combined with STMicroelectronics' well-known PowerMESH™ horizontal layout structure. The resulting product has extremely low on-resistance, which is unmatched among silicon-based Power MOSFETs, making it especially suitable for applications which require superior power density and outstanding efficiency.

Figure 1. Internal schematic diagram

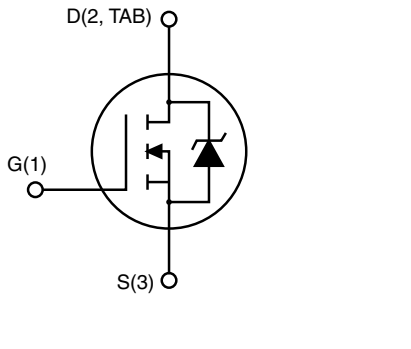


Table 1. Device summary

Order codes	Marking	Package	Packaging
STP36N55M5	36N55M5	TO-220	Tube
STW36N55M5		TO-247	

Contents

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 25	V
I_D	Drain current (continuous) at T_C = 25 °C	33	A
I_D	Drain current (continuous) at T_C = 100 °C	20.8	A
I_{DM} (1)	Drain current (pulsed)	132	A
P_{TOT}	Total dissipation at T_C = 25 °C	190	W
dv/dt (1)	Peak diode recovery voltage slope	15	V/ns
T_{stg}	Storage temperature	- 55 to 150	°C
T_j	Max. operating junction temperature	150	°C

1. $I_{SD} \leq 33$ A, di/dt ≤400 A/µs; $V_{DS(Peak)} < V_{(BR)DSS}$, V_{DD} = 340 V.

Table 3. Thermal data

Symbol	Parameter	Value		Unit
		TO-220	TO-247	
$R_{thj\text{-}case}$	Thermal resistance junction-case max	0.66		°C/W
$R_{thj\text{-}amb}$	Thermal resistance junction-ambient max	62.5	50	°C/W

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I_{AR}	Avalanche current, repetetive or not repetetive (pulse width limited by T_{jmax})	7	A
E_{AS}	Single pulse avalanche energy (starting T_J=25°C, I_D= I_{AR}; V_{DD}=50 V)	510	mJ

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	I_D = 1 mA, V_{GS} = 0	550			V
I_{DSS}	Zero gate voltage drain current (V_{GS} = 0)	V_{DS} = 550 V V_{DS} = 550 V, T_C=125 °C			1 100	µA µA
I_{GSS}	Gate-body leakage current (V_{DS} = 0)	V_{GS} = ± 25 V			± 100	nA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS}, I_D = 250 µA	3	4	5	V
$R_{DS(on)}$	Static drain-source on-resistance	V_{GS} = 10 V, I_D = 16.5 A		0.06	0.08	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{iss} C_{oss} C_{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V_{DS} = 100 V, f = 1 MHz, V_{GS} = 0	-	2670 75 6.6	-	pF pF pF
$C_{o(tr)}$(1)	Equivalent capacitance time related	V_{DS} = 0 to 440 V, V_{GS} = 0	-	192	-	pF
$C_{o(er)}$(2)	Equivalent capacitance energy related		-	71	-	pF
R_G	Intrinsic gate resistance	f = 1 MHz open drain	-	1.85	-	Ω
Q_g Q_{gs} Q_{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} = 440 V, I_D = 16.5 A, V_{GS} = 10 V (see *Figure 18*)	-	62 15 27	-	nC nC nC

1. Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}
2. Energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
$t_{d(V)}$	Voltage delay time	V_{DD} = 400 V, I_D = 22 A,	-	56	-	ns
$t_{r(V)}$	Voltage rise time	R_G = 4.7 Ω, V_{GS} = 10 V		13		ns
$t_{f(i)}$	Current fall time	(see *Figure 19* and		13		ns
$t_{c(off)}$	Crossing time	*Figure 22*)		17		ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{SD}	Source-drain current		-		33	A
I_{SDM} (1)	Source-drain current (pulsed)				132	A
V_{SD} (2)	Forward on voltage	I_{SD} = 33 A, V_{GS} = 0	-		1.5	V
t_{rr}	Reverse recovery time	I_{SD} = 33 A, di/dt = 100 A/µs	-	334		ns
Q_{rr}	Reverse recovery charge	V_{DD} = 100 V (see *Figure 22*)		5		µC
I_{RRM}	Reverse recovery current			31		A
t_{rr}	Reverse recovery time	I_{SD} = 33 A, di/dt = 100 A/µs	-	406		ns
Q_{rr}	Reverse recovery charge	V_{DD} = 100 V, T_j = 150 °C		7		µC
I_{RRM}	Reverse recovery current	(see *Figure 22*)		35		A

1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300 µs, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220

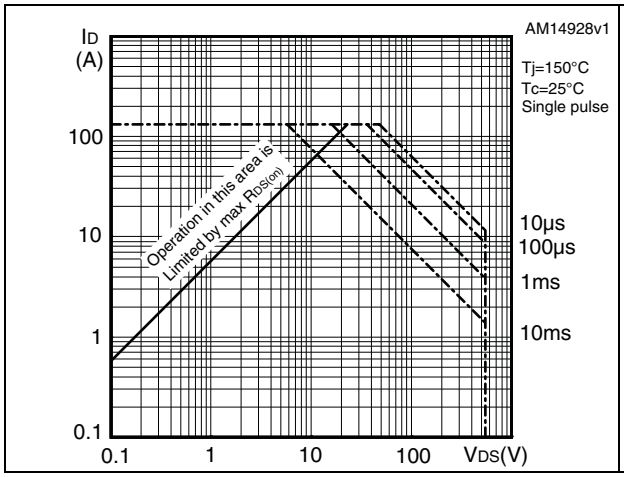


Figure 3. Thermal impedance for TO-220

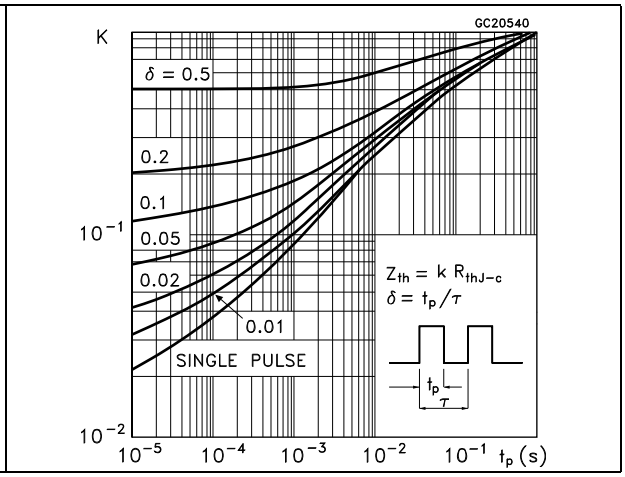


Figure 4. Safe operating area for TO-247

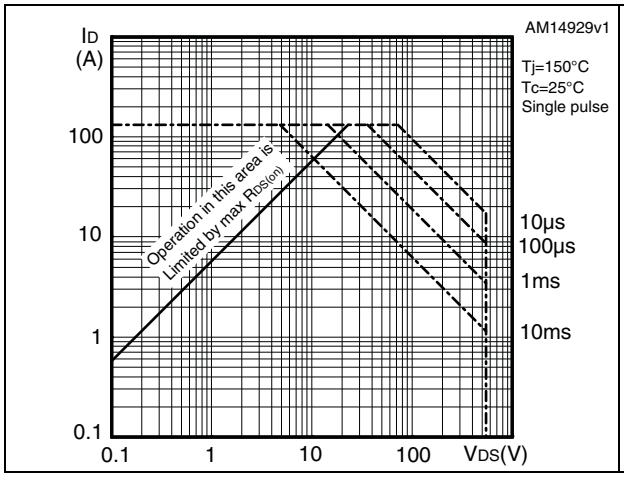


Figure 5. Thermal impedance for TO-247

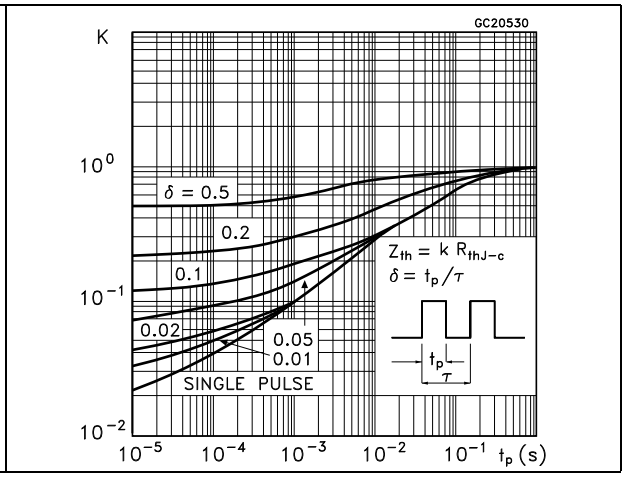


Figure 6. Output characteristics

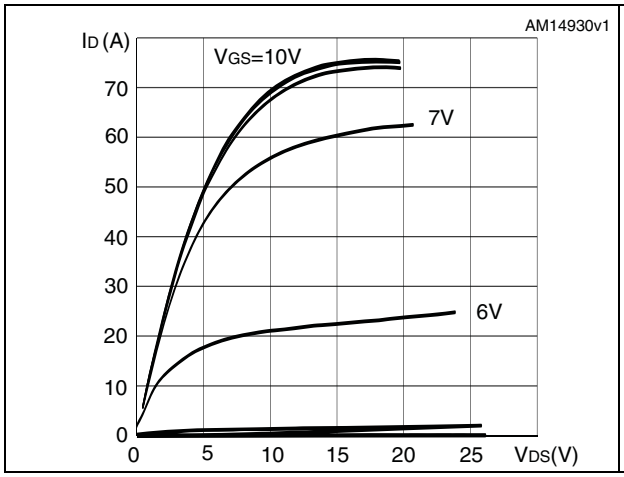


Figure 7. Transfer characteristics

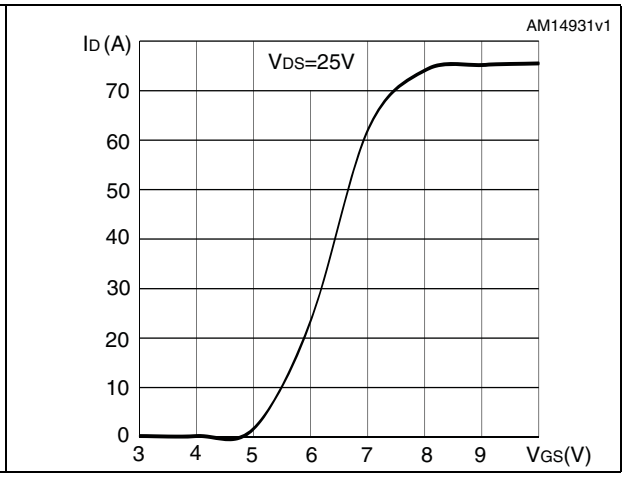


Figure 8. Gate charge vs gate-source voltage

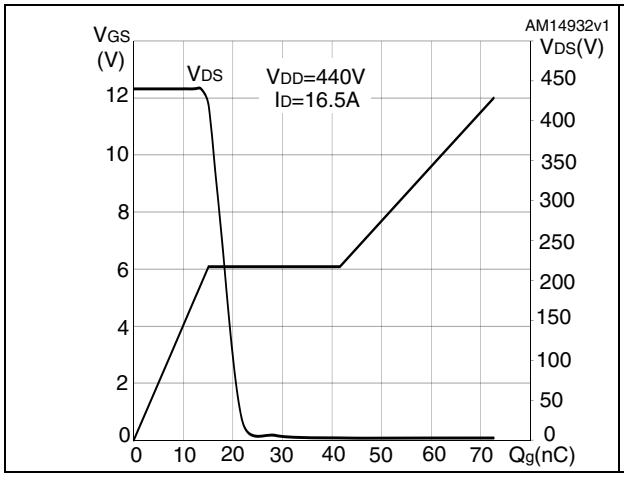


Figure 9. Static drain-source on-resistance

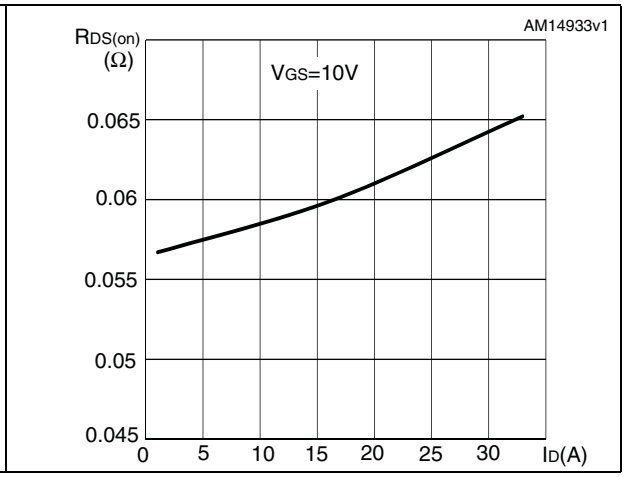


Figure 10. Capacitance variations

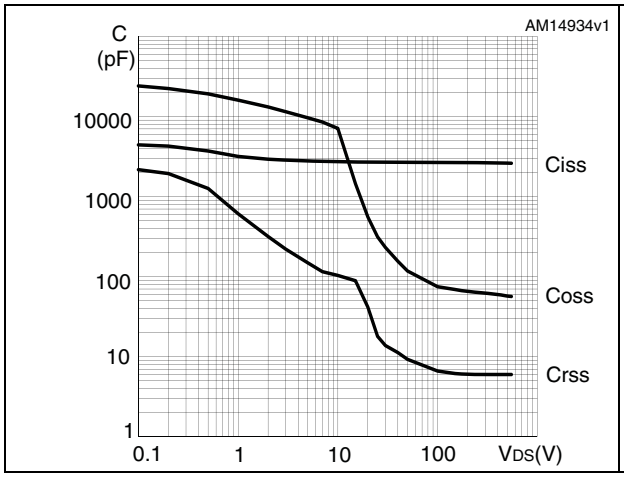


Figure 11. Output capacitance stored energy

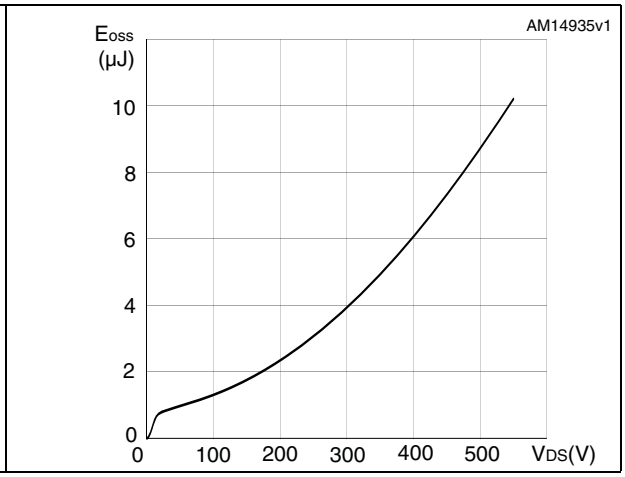


Figure 12. Normalized gate threshold voltage vs temperature

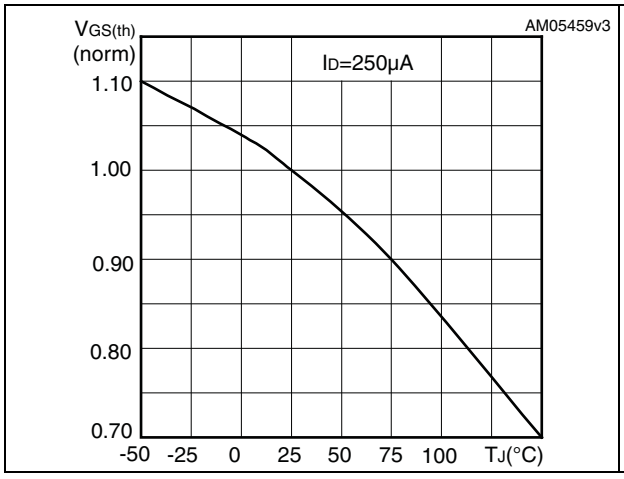


Figure 13. Normalized on-resistance vs temperature

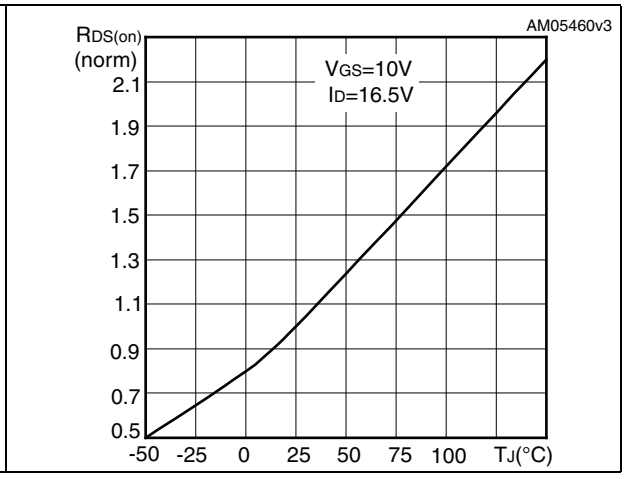


Figure 14. Source-drain diode forward characteristics

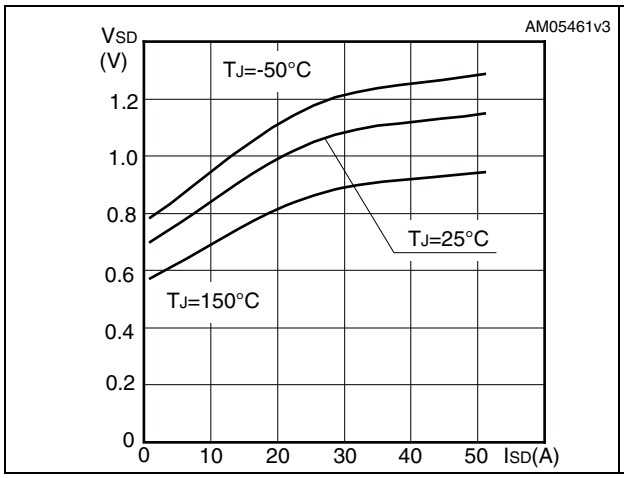


Figure 15. Normalized B_{VDSS} vs temperature

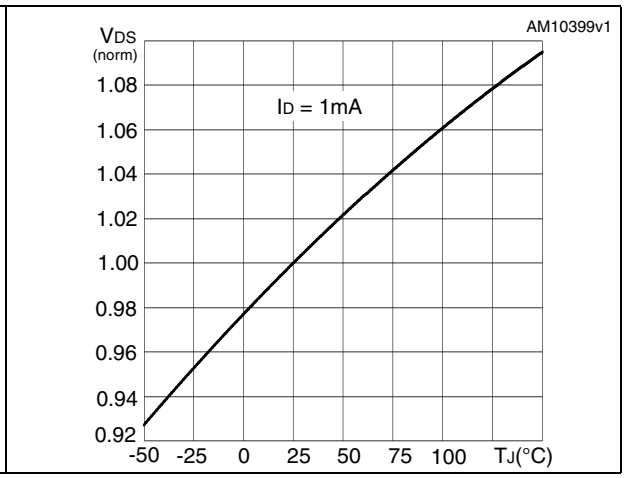
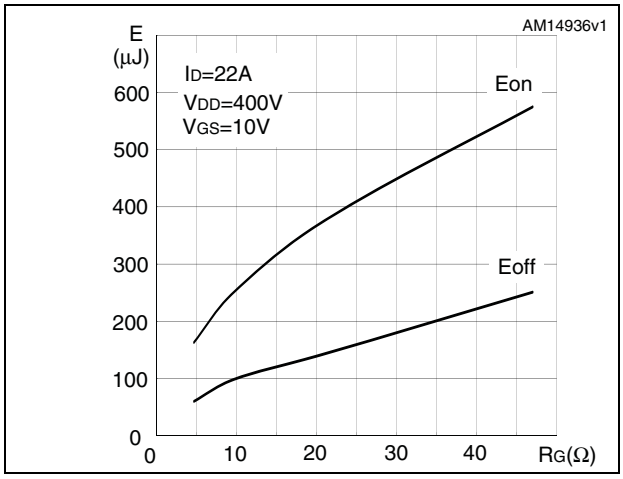


Figure 16. Switching losses vs gate resistance (1)



1. Eon including reverse recovery of a SiC diode

3 Test circuits

Figure 17. Switching times test circuit for resistive load

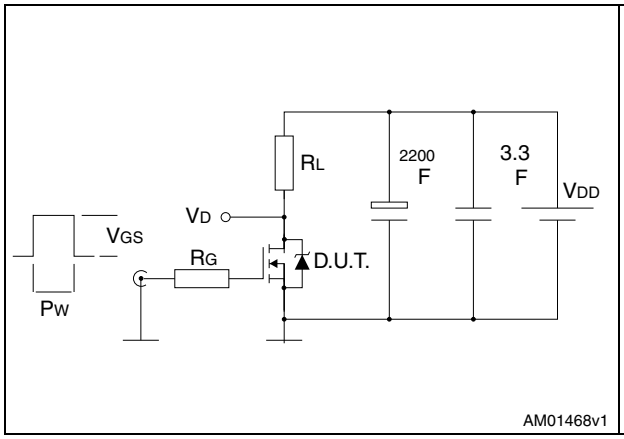


Figure 18. Gate charge test circuit

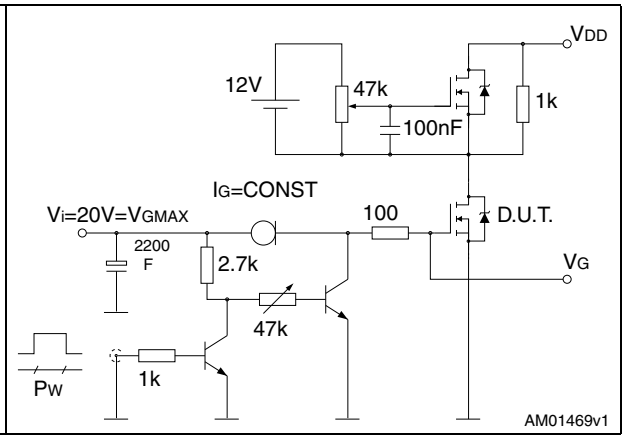


Figure 19. Test circuit for inductive load switching and diode recovery times

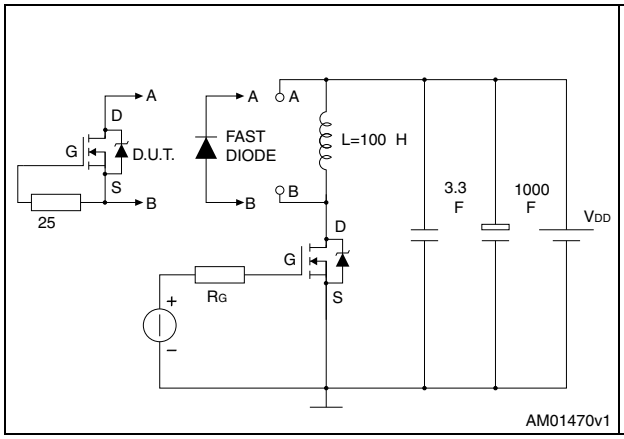


Figure 20. Unclamped inductive load test circuit

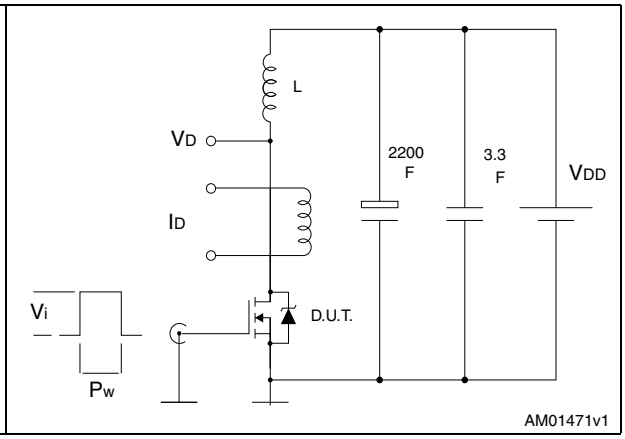


Figure 21. Unclamped inductive waveform

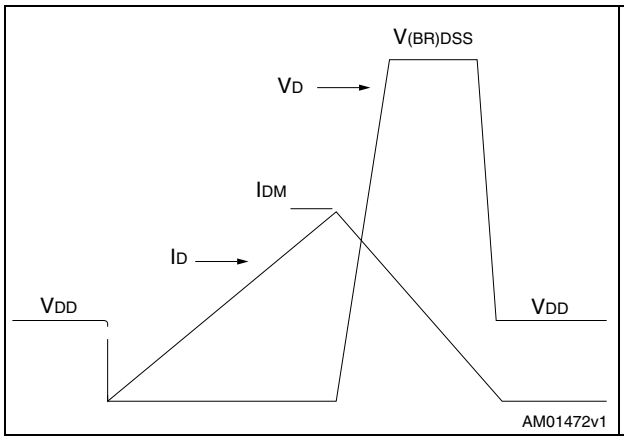
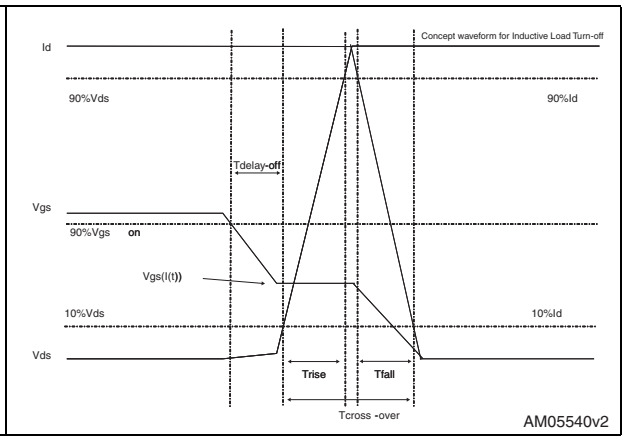


Figure 22. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.

Table 9. TO-220 type A mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
∅P	3.75		3.85
Q	2.65		2.95

Figure 23. TO-220 type A drawing

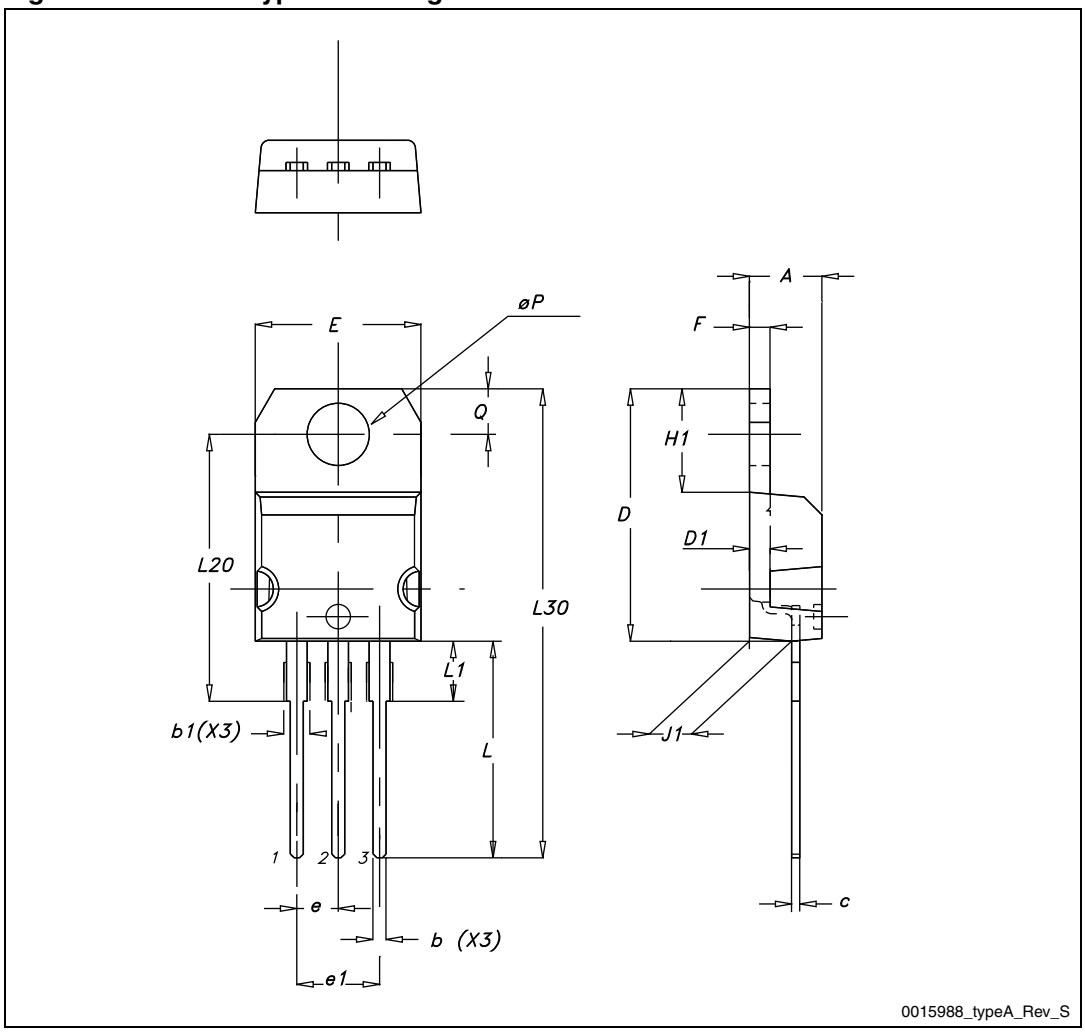
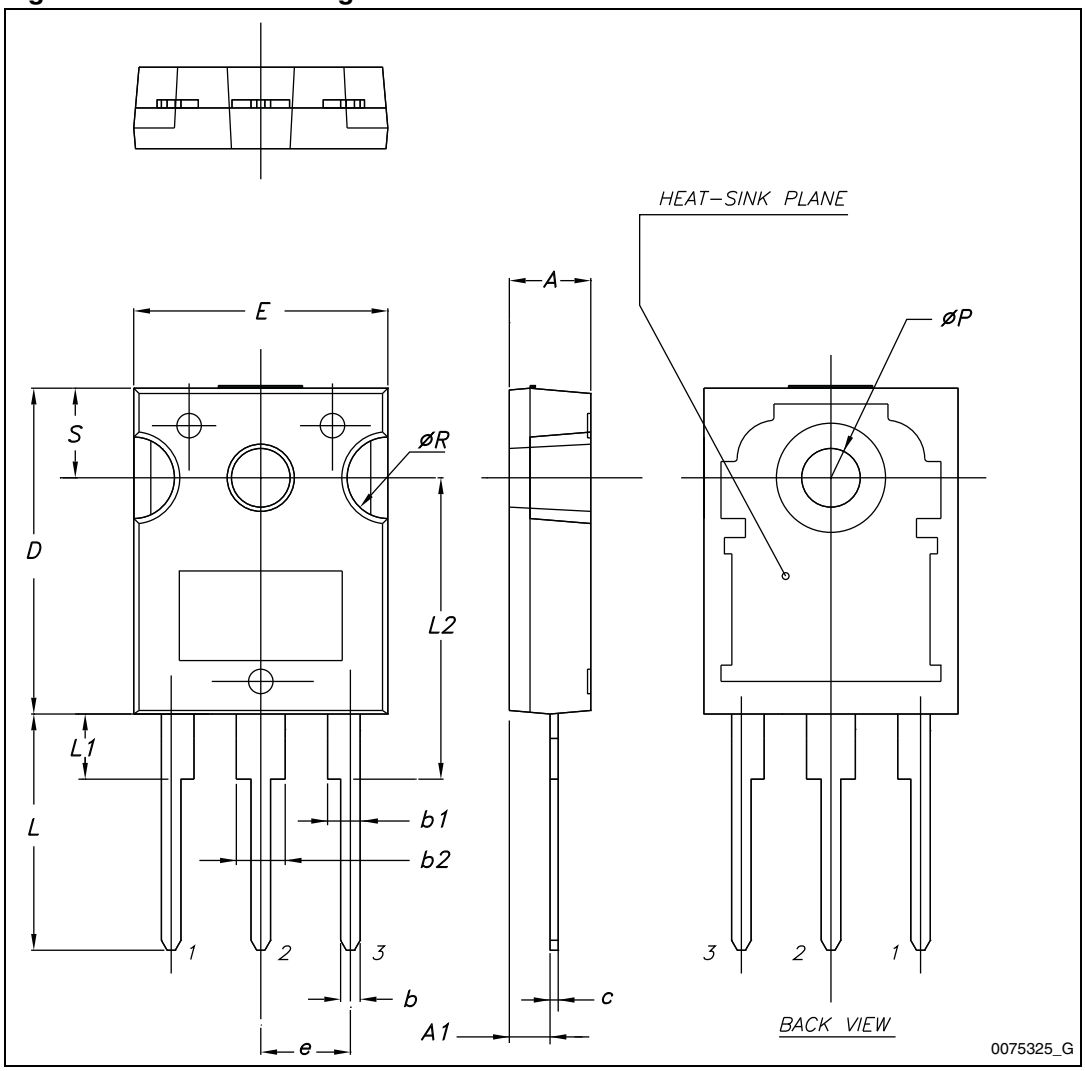


Table 10. TO-247 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
∅P	3.55		3.65
∅R	4.50		5.50
S	5.30	5.50	5.70

Figure 24. TO-247 drawing



5 Revision history

Table 11. Document revision history

Date	Revision	Changes
07-Mar-2012	1	First release.
23-Oct-2012	2	Document status promoted from preliminary data to production data.

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